

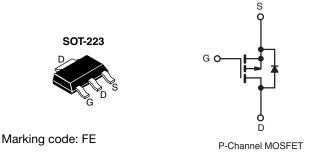
Vishay Siliconix

COMPLIANT HALOGEN

FREE

Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V)	-60	
$R_{DS(on)}(\Omega)$	V _{GS} = -10 V	0.50
Q _g (Max.) (nC)	12	
Q _{gs} (nC)	3.8	
Q _{gd} (nC)	5.1	
Configuration	Sing	le



FEATURES

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- · Repetitive avalanche rated
- P-channel
- · Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mounting using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION		
Package	SOT-223	SOT-223
Lead (Pb)-free and Halogen-free	SiHFL9014-GE3	SiHFL9014TR-GE3
Load (Db) free	IRFL9014PbF	IRFL9014TRPbF ^a
Lead (Pb)-free	SiHFL 9014-F3	SiHFI 9014T-F3 a

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (To	, ,	1			1	
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	-60	V	
Gate-Source Voltage		V_{GS}	± 20	V		
Continuous Drain Current	Vac at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	_	-1.8		
Continuous Drain Current	VGS at - 10 V	T _C = 100 °C	I _D	-1.1	A	
Pulsed Drain Current ^a			I_{DM}	-14		
Linear Derating Factor				0.025	W//°C	
Linear Derating Factor (PCB Mount) e				0.017	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	140	mJ	
Repetitive Avalanche Current ^a			I _{AR}	-1.8	А	
Repetitive Avalanche Energy ^a			E _{AR}	0.31	mJ	
Maximum Power Dissipation		T _C = 25 °C		3.1	W	
Maximum Power Dissipation (PCB Mount) e	T _A =	25 °C	P_D	2.0	VV	
Peak Diode Recovery dV/dt ^c	Peak Diode Recovery dV/dt ^c		dV/dt	-4.5	V/ns	
Operating Junction and Storage Temperature Range	ge		T _J , T _{stg}	-55 to +150	°C	
Soldering Recommendations (Peak Temperature)	ecommendations (Peak Temperature) d for 10 s			300	7	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- V_{DD} = 25 V, starting T_J = 25 °C, L = 50 mH, R_g = 25 Ω , I_{AS} = 1.8 A (see fig. 12). I_{SD} ≤ 6.7 A, dl/dt ≤ 90 A/µs, V_{DD} ≤ V_{DS} , V_{DS} = 150 °C. 1.6 mm from case.

- When mounted on 1" square PCB (FR-4 or G-10 material).



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THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	60	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	-60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	-0.059	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	-2.0	-	-4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zava Cata Valtaga Dvain Cuwant	1	V _{DS} :	= -60 V, V _{GS} = 0 V	-	-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -48 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	-500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = 1.1 A ^b	-	-	0.50	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	- 25 V, I _D = 1.1 A ^b	1.3	-	-	S
Dynamic		•					
Input Capacitance	C _{iss}		V _{GS} = 0 V.		270	-	
Output Capacitance	Coss	1	$V_{DS} = 25 \text{ V},$	-	170	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1	f = 1.0 MHz, see fig. 5		31	-	
Total Gate Charge	Qg			-	-	12	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$I_D = -6.7 \text{ A}, V_{DS} = -48 \text{ V},$ see fig. 6 and 13 b	-	-	3.8	nC
Gate-Drain Charge	Q _{gd}		ground to	-	-	5.1	
Turn-On Delay Time	t _{d(on)}			-	11	-	
Rise Time	t _r	V_{DD} = - 30 V, I_{D} = - 6.7 A, R_{g} = 24 Ω , R_{D} = 4.0 Ω , see fig. 10 b		-	63	-	ns
Turn-Off Delay Time	t _{d(off)}			-	9.6	-	
Fall Time	t _f	7		-	31	-	1
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from		-	4.0	-	nH
Internal Source Inductance	L _S	package and die contact	package and center of die contact		6.0	-	11111
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	- 1.8	Α
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	- 14	
Body Diode Voltage	V_{SD}	T _J = 25 °C,	$I_S = -1.8 \text{ A}, V_{GS} = 0 \text{ V}^{\text{ b}}$	-	-	- 5.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1			80	160	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$\frac{1}{1} = 25 \text{ °C, I}_{\text{F}} = 25 \text{ °C}$	= - 6.7 A, dl/dt = 100 A/μs b	-	0.096	0.19	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is do	minated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

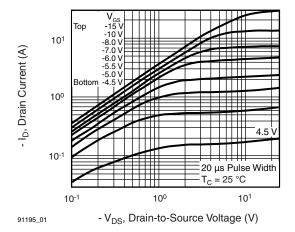


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

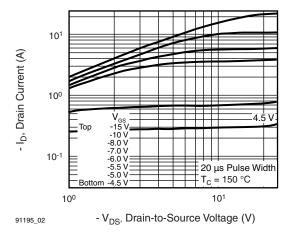


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

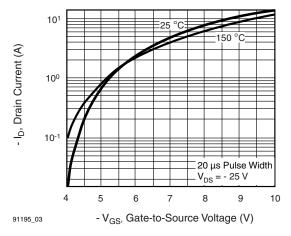


Fig. 3 - Typical Transfer Characteristics

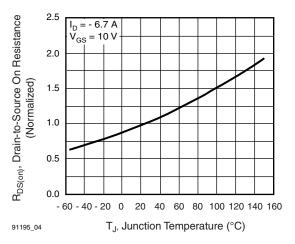


Fig. 4 - Normalized On-Resistance vs. Temperature

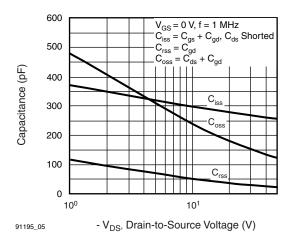


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

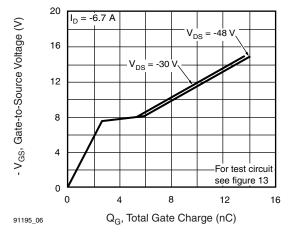


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



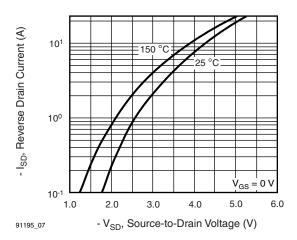


Fig. 7 - Typical Source-Drain Diode Forward Voltage

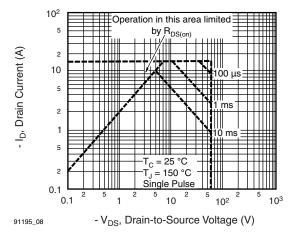


Fig. 8 - Maximum Safe Operating Area

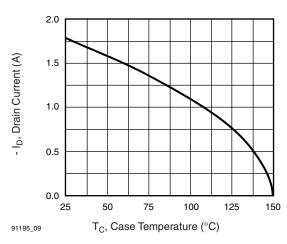


Fig. 9 - Maximum Drain Current vs. Case Temperature

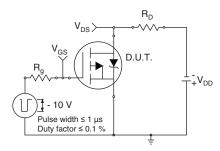


Fig. 10a - Switching Time Test Circuit

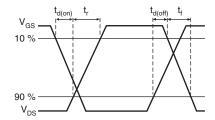


Fig. 10b - Switching Time Waveforms

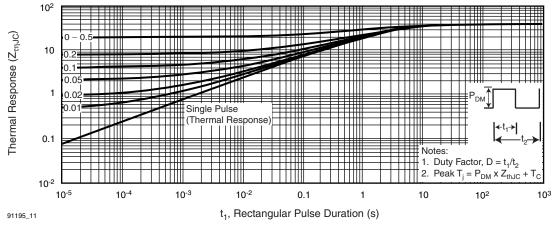


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



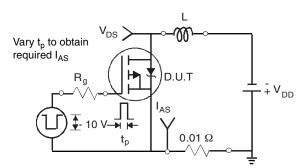


Fig. 12a - Unclamped Inductive Test Circuit

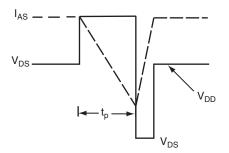


Fig. 12b - Unclamped Inductive Waveforms

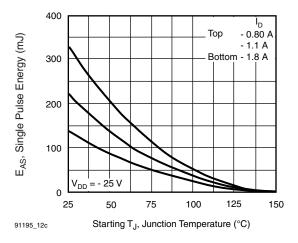


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

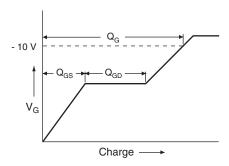


Fig. 13a - Basic Gate Charge Waveform

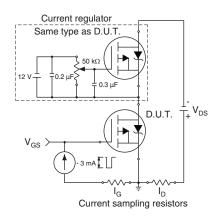
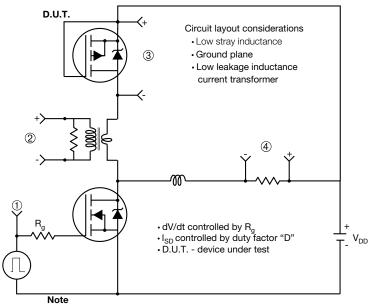


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

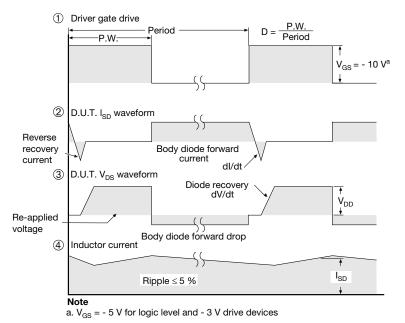


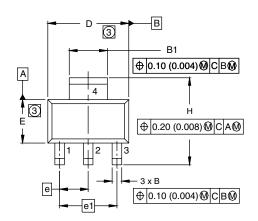
Fig. 14 - For P-Channel

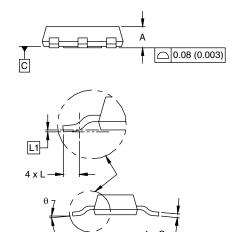
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SOT-223 (HIGH VOLTAGE)





DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	1.55	1.80	0.061	0.071
В	0.65	0.85	0.026	0.033
B1	2.95	3.15	0.116	0.124
С	0.25	0.35	0.010	0.014
D	6.30	6.70	0.248	0.264
E	3.30	3.70	0.130	0.146
е	2.30 BSC		0.0905 BSC	
e1	4.60	O BSC	0.181	BSC
Н	6.71	7.29	0.264	0.287
L	0.91	-	0.036	=
L1	0.061 BSC		0.0024	BSC
θ	-	10'	-	10'

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.

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